

## **N-Channel JFET Low-Frequency Low-Noise Amplifier**

- 1. Drain
- 2. Source
- 3. Gate

#### SOT-23 CASE 318-08

### BSR58

#### Description

This device is designed for low-power chopper or switching application sourced from process 51.

#### **ABSOLUTE MAXIMUM RATINGS**

(T<sub>C</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Value	Unit
$V_{DGO}$	Drain-Gate Voltage	40	V
V <sub>GSO</sub>	Gate-Source Voltage	-40	V
I <sub>GF</sub>	Forward Gate Current	50	mA
P <sub>tot</sub>	Total Power Dissipation Up to T <sub>amb</sub> = 40°C	250	mW
T <sub>STG</sub>	Storage Temperature Range	-55 to +150	°C
TJ	Junction Temperature	150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### MARKING DIAGRAM



M6 = Specific Device Code

М = Date Code = Pb-Free Package

(Note: Microdot may be in either location)

#### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
BSR58	SOT-23 (Pb-Free)	3000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

### **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
BV <sub>GSS</sub>	Gate-Source Voltage	$V_{DS}$ = 0 V, $I_{C}$ = 1.0 $\mu A$	40.0	_	-	V
I <sub>GSS</sub>	Gate Reverse Current	V <sub>GS</sub> = 20 V	_	_	1.0	nA
I <sub>DSS</sub>	Zero-Gate Voltage Drain Current	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}$	8.0	-	80.0	mA
V <sub>GS</sub> (off)	Gate-Source Cut-off Voltage	$V_{DS} = 15 \text{ V}, I_{D} = 0.5 \text{ nA}$	0.8	_	4.0	V
V <sub>DS</sub> (on)	Drain-Source On Voltage	$V_{GS} = 0 \text{ V, } I_D = 5 \text{ mA}$	-	-	0.4	V
r <sub>ds</sub> (on)	Drain-Source On Reverse	$V_{GS} = 0 \text{ V}, I_D = 0 \text{ mA}$	-	-	60.0	Ω
C <sub>rss</sub>	Reverse Transfer Capacitance	$V_{DS} = 0 \text{ V}, V_{GS} = 10 \text{ V}$	_	-	5.0	pF
t <sub>d</sub>	Delay Time	$V_{DD} = 10 \text{ V}, V_{GS}(on) = 0 \text{ V}$	_	_	10.0	ns
t <sub>r</sub>	Rise Time	I <sub>D</sub> = 10 mA, V <sub>GS</sub> (off) = 10.0 V	_	_	10.0	
t <sub>off</sub>	Turn-off Time		_	_	100.0	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

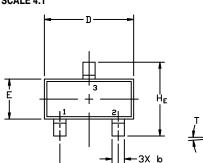
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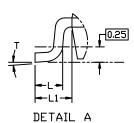


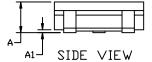


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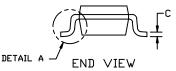
**DATE 01 MAR 2023** 







TOP VIEW



#### NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M,1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL.
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

	MILLIMETERS			INCHES		
DIM	MIN.	N□M.	MAX.	MIN.	N□M.	MAX.
Α	0.89	1.00	1.11	0.035	0.039	0.044
A1	0.01	0.06	0.10	0.000	0.002	0.004
b	0.37	0.44	0.50	0.015	0.017	0.020
С	0.08	0.14	0.20	0.003	0.006	0.008
D	2.80	2.90	3.04	0.110	0.114	0.120
Ε	1.20	1.30	1.40	0.047	0.051	0.055
e	1.78	1.90	2.04	0.070	0.075	0.080
L	0.30	0.43	0.55	0.012	0.017	0.022
L1	0.35	0.54	0.69	0.014	0.021	0.027
HE	2.10	2.40	2.64	0.083	0.094	0.104
Т	0*		10°	0*		10°

# GENERIC MARKING DIAGRAM\*

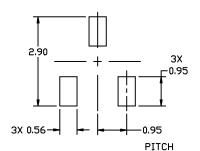


XXX = Specific Device Code

M = Date Code

■ = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



RECOMMENDED MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

### **STYLES ON PAGE 2**

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# MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS



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STYLE 1 THRU 5: CANCELLED	STYLE 6: PIN 1. BASE 2. EMITTER 3. COLLECTOR	STYLE 7: PIN 1. EMITTER 2. BASE 3. COLLECTOR	STYLE 8: PIN 1. ANODE 2. NO CONNECTION 3. CATHODE	N	
STYLE 9:	STYLE 10:	STYLE 11:	STYLE 12: PIN 1. CATHODE 2. CATHODE 3. ANODE	STYLE 13:	STYLE 14:
PIN 1. ANODE	PIN 1. DRAIN	PIN 1. ANODE		PIN 1. SOURCE	PIN 1. CATHODE
2. ANODE	2. SOURCE	2. CATHODE		2. DRAIN	2. GATE
3. CATHODE	3. GATE	3. CATHODE-ANODE		3. GATE	3. ANODE
STYLE 15:	STYLE 16:	STYLE 17:	STYLE 18:	STYLE 19:	STYLE 20:
PIN 1. GATE	PIN 1. ANODE	PIN 1. NO CONNECTION	PIN 1. NO CONNECTION	N PIN 1. CATHODE	PIN 1. CATHODE
2. CATHODE	2. CATHODE	2. ANODE	2. CATHODE	2. ANODE	2. ANODE
3. ANODE	3. CATHODE	3. CATHODE	3. ANODE	3. CATHODE-ANODE	3. GATE
STYLE 21:	STYLE 22:	STYLE 23:	STYLE 24:	STYLE 25:	STYLE 26:
PIN 1. GATE	PIN 1. RETURN	PIN 1. ANODE	PIN 1. GATE	PIN 1. ANODE	PIN 1. CATHODE
2. SOURCE	2. OUTPUT	2. ANODE	2. DRAIN	2. CATHODE	2. ANODE
3. DRAIN	3. INPUT	3. CATHODE	3. SOURCE	3. GATE	3. NO CONNECTION
STYLE 27: PIN 1. CATHODE 2. CATHODE 3. CATHODE	STYLE 28: PIN 1. ANODE 2. ANODE 3. ANODE				

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